# **COP472-3**

COP472-3 Liquid Crystal Display Controller



Literature Number: SNOSBQ3



# **COP472-3 Liquid Crystal Display Controller**

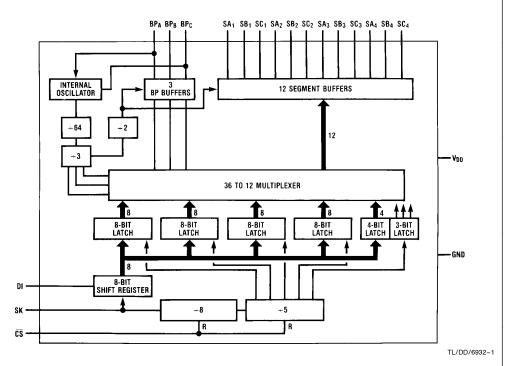
## **General Description**

The COP472–3 Liquid Crystal Display (LCD) Controller is a peripheral member of the COPSTM family, fabricated using CMOS technology. The COP472-3 drives a multiplexed liquid crystal display directly. Data is loaded serially and is held in internal latches. The COP472-3 contains an on-chip oscillator and generates all the multi-level waveforms for backplanes and segment outputs on a triplex display. One COP472-3 can drive 36 segments multiplexed as 3  $\times$  12 (4½ digit display). Two COP472-3 devices can be used together to drive 72 segments (3  $\times$  24) which could be an 8½ digit display.

## **Features**

- Direct interface to TRIPLEX LCD
- Low power dissipation (100 µW typ.)
- Low cost
- Compatible with all COPS processors
- Needs no refresh from processor
- On-chip oscillator and latches
- Expandable to longer displays
- Operates from display voltage
- MICROWIRE™ compatible serial I/O
- 20-pin Dual-In-Line package and 20-pin SO

## **Block Diagram**



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## **Absolute Maximum Ratings**

Voltage at CS, DI, SK pins -0.3V to +9.5VVoltage at all other Pins -0.3V to  $V_{DD} + 0.3V$ Operating Temperature Range  $0^{\circ}\text{C}$  to  $70^{\circ}\text{C}$ 

Storage Temperature Lead Temp. (Soldering, 10 Seconds)  $-65^{\circ}$ C to  $+150^{\circ}$ C 300°C

## **DC Electrical Characteristics**

GND = 0V, V<sub>DD</sub> = 3.0V to 5.5V, T<sub>A</sub> = 0°C to 70°C (depends on display characteristics)

Parameter	Conditions	Min	Max	Units
Power Supply Voltage, V <sub>DD</sub>		3.0	5.5	Volts
Power Supply Current, I <sub>DD</sub> (Note 1)	V <sub>DD</sub> =5.5V		250	μΑ
	V <sub>DD</sub> =3V		100	μΑ
Input Levels				
DI, SK, CS				
V <sub>IL</sub>			0.8	Volts
V <sub>IH</sub>		0.7 V <sub>DD</sub>	9.5	Volts
BPA (as Osc. in)				
V <sub>IL</sub>			0.6	Volts
V <sub>IH</sub>		V <sub>DD</sub> -0.6	V <sub>DD</sub>	Volts
Output Levels, BPC (as Osc. Out)				
$V_{OL}$			0.4	Volts
V <sub>OH</sub>		V <sub>DD</sub> -0.4	V <sub>DD</sub>	Volts
Backplane Outputs (BPA, BPB, BPC)				
$V_{BPA, BPB, BPC}$ ON	During	$V_{DD}-\Delta V$	$V_{DD}$	Volts
V <sub>BPA, BPB, BPC</sub> OFF	BP+ Time	1/ <sub>3</sub> V <sub>DD</sub> – ΔV	$\frac{1}{3}$ V <sub>DD</sub> + $\Delta$ V	Volts
V <sub>BPA, BPB, BPC</sub> ON	During	0	ΔV	Volts
V <sub>BPA, BPB, BPC</sub> OFF	BP- Time	$^{2}/_{3}$ $V_{DD} - \Delta V$	$^{2}/_{3}$ $V_{DD} + \Delta V$	Volts
Segment Outputs (SA <sub>1</sub> ∼ SA <sub>4</sub> )				
V <sub>SEG</sub> ON	During	0	ΔV	Volts
V <sub>SEG</sub> OFF	BP+ Time	$^{2}/_{3}$ $V_{DD} - \Delta V$	$^{2}/_{3}$ $V_{DD} + \Delta V$	Volts
V <sub>SEG</sub> ON	During	$V_{DD}-\Delta V$	V <sub>DD</sub>	Volts
V <sub>SEG</sub> OFF	BP- Time	$^{1}/_{3}V_{DD}-\Delta V$	$\frac{1}{3}$ $V_{DD} + \Delta V$	Volts
Internal Oscillator Frequency		15	80	kHz
Frame Time (Int. Osc. ÷ 192)		2.4	12.8	ms
Scan Frequency (1/T <sub>SCAN</sub> )		39	208	Hz
SK Clock Frequency		4	250	kHz
SK Width		1.7		μs
DI				
Data Setup, t <sub>SETUP</sub>		1.0		μs
Data Hold, t <sub>HOLD</sub>		100		ns
<u>CS</u>				
<sup>t</sup> SETUP		1.0		μs
thold		1.0		μs
Output Loading Capacitance			100	pF

Note 1: Power supply current is measured in stand-alone mode with all outputs open and all inputs at VDD. Note 2:  $\Delta V\!=\!0.05V_{DD}.$ 

## **Absolute Maximum Ratings**

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

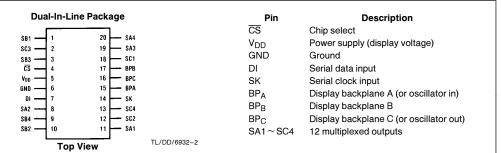
 $\begin{array}{ll} \mbox{Storage Temperature} & -65^{\circ}\mbox{C to } +150^{\circ}\mbox{C} \\ \mbox{Lead Temperature} & \\ \mbox{(Soldering, 10 seconds)} & 300^{\circ}\mbox{C} \\ \end{array}$ 

## **DC Electrical Characteristics**

GND = 0V,  $V_{DD}$  = 3.0V to 5.5V,  $T_A$  =  $-40^{\circ}C$  to  $+85^{\circ}C$  (depends on display characteristics)

Parameter	Conditions	Min	Max	Units	
Power Supply Voltage, V <sub>DD</sub>		3.0	5.5	Volts	
Power Supply Current, I <sub>DD</sub> (Note 1)	V <sub>DD</sub> =5.5V		300	μΑ	
	V <sub>DD</sub> =3V		120	μΑ	
Input Levels					
DI, SK, CS					
V <sub>IL</sub>		0.71/	0.8	Volts	
V <sub>IH</sub>		0.7 V <sub>DD</sub>	9.5	Volts	
BPA (as Osc. In)				.,,,,,	
V <sub>IL</sub>		.,	0.6	Volts	
V <sub>IH</sub>		V <sub>DD</sub> -0.6	V <sub>DD</sub>	Volts	
Output Levels, BPC (as Osc. Out)					
V <sub>OL</sub>			0.4	Volts	
V <sub>OH</sub>		V <sub>DD</sub> -0.4	V <sub>DD</sub>	Volts	
Backplane Outputs (BPA, BPB, BPC)					
V <sub>BPA, BPB, BPC</sub> ON	During	$V_{DD}-\Delta V$	V <sub>DD</sub>	Volts	
V <sub>BPA, BPB, BPC</sub> OFF	BP+ Time	$^{1}/_{3}$ $V_{DD} - \Delta V$	1/ <sub>3</sub> V <sub>DD</sub> + ΔV	Volts	
V <sub>BPA, BPB, BPC</sub> ON	During	0	ΔV	Volts	
V <sub>BPA, BPB, BPC</sub> OFF	BP- Time	$^{2}/_{3}$ $V_{DD} - \Delta V$	$^{2}/_{3}$ $V_{DD} + \Delta V$	Volts	
Segment Outputs (SA <sub>1</sub> ∼ SA <sub>4</sub> )					
V <sub>SEG</sub> ON	During	0	ΔV	Volts	
V <sub>SEG</sub> OFF	BP+ Time	$^{2}/_{3}$ $V_{DD} - \Delta V$	$^{2}/_{3}$ $V_{DD} + \Delta V$	Volts	
V <sub>SEG</sub> ON	During	$V_{DD}-\Delta V$	V <sub>DD</sub>	Volts	
V <sub>SEG</sub> OFF	BP- Time	$^{1}/_{3}V_{DD}-\Delta V$	$\frac{1}{3}$ V <sub>DD</sub> + $\Delta$ V	Volts	
Internal Oscillator Frequency		15	80	kHz	
Frame Time (Int. Osc. ÷ 192)		2.4	12.8	ms	
Scan Frequency (1/T <sub>SCAN</sub> )		39	208	Hz	
SK Clock Frequency		4	250	kHz	
SK Width		1.7		μs	
DI					
Data Setup, t <sub>SETUP</sub>		1.0		μs	
Data Hold, t <sub>HOLD</sub>		100		ns	
<u>CS</u>					
<sup>t</sup> SETUP		1.0		μs	
<sup>t</sup> HOLD		1.0		μs	
Output Loading Capacitance			100	pF	

Note 1: Power supply current is measured in stand-alone mode with all outputs open and all inputs at  $V_{DD}$ . Note 2:  $\Delta V = 0.05 \ V_{DD}$ .



Order Number COP472MW-3 or COP472N-3 See NS Package Number M20A or N20A

FIGURE 2. Connection Diagram

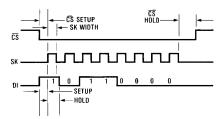


FIGURE 3. Serial Load Timing Diagram

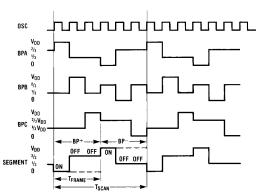


FIGURE 4. Backplane and Segment Waveforms

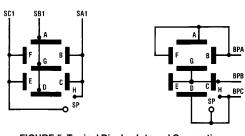


FIGURE 5. Typical Display Internal Connections Epson LD-370 TL/DD/6932-5

TL/DD/6932-4

TL/DD/6932-3

## **Functional Description**

The COP472-3 drives 36 bits of display information organized as twelve segments and three backplanes. The COP472-3 requires 40 information bits: 36 data and 4 control. The function of each control bit is described below. Display information format is a function of the LCD interconnections. A typical segment/backplane configuration is illustrated in *Figure 5*, with this configuration the COP472-3 will drive 4 digits of 9 segments.

To adapt the COP472-3 to any LCD display configuration, the segment/backplane multiplex scheme is illustrated in Table I

Two or more COP472-3 chips can be cascaded to drive additional segments. There is no limit to the number of COP472-3's that can be used as long as the output loading capacitance does not exceed specification.

TABLE I. COP472-3 Segment/Backplane Multiplex Scheme

Multiplex Scheme						
Bit Number Segment, Backplane		Data to Numeric Display				
1	SA1, BPC	SH				
2	SB1, BPB	SG				
3	SC1, BPA	SF				
4	SC1, BPB	SE	Digit 1			
5	SB1, BPC	SD	Digit i			
6	SA1, BPB	SC				
7	SA1, BPA	SB				
8	SB1, BPA	SA				
9	SA2, BPC	SH				
10	SB2, BPB	SG				
11	SC2, BPA	SF				
12	SC2, BPB	SE	Digit 2			
13	SB2, BPC	SD	Digit 2			
14	SA2, BPB	SC				
15	SA2, BPA	SB				
16	SB2, BPA	SA				
17	SA3, BPC	SH				
18	SB3, BPB	SG				
19	SC3, BPA	SF				
20	SC3, BPB	SE	Digit 3			
21	SB3, BPC	SD	Digit o			
22	SA3, BPB	SC				
23	SA3, BPA	SB				
24	SB3, BPA	SA				
25	SA4, BPC	SH				
26	SB4, BPB	SG				
27	SC4, BPA	SF				
28	SC4, BPB	SE	Digit 4			
29	SB4, BPC	SD	Digit 4			
30	SA4, BPB	SC				
31	SA4, BPA	SB				
32	SB4, BPA	SA				
33	SC1, BPC	SPA	Digit 1			
34	SC2, BPC	SP2	Digit 2			
35	SC3, BPC	SP3	Digit 3			
36	SC4, BPC	SP4	Digit 4			
37	not used					
38	Q6					
39	Q7					
40	SYNC					

### **SEGMENT DATA BITS**

Data is loaded in serially, in sets of eight bits. Each set of segment data is in the following format:

1								
	SA	l SR	l sc	l sd	SF	SF	SG	SH
	- C/ (	00	, 50	00		, J	, Ju	J 011

Data is shifted into an eight bit shift register. The first bit of the data is for segment H, digit 1. The eighth bit is segment A, digit 1. A set of eight bits is shifted in and then loaded into the digit one latches. The second set of 8 bits is loaded into digit two latches. The third set into digit three latches, and the fourth set is loaded into digit four latches.

#### **CONTROL BITS**

The fifth set of 8 data bits contains special segment data and control data in the following format:

SYNC	Q7	Q6	Х	SP4	SP3	SP2	SP1

The first four bits shifted in contain the special character segment data. The fifth bit is not used. The sixth and seventh bits program the COP472-3 as a stand alone LCD driver or as a master or slave for cascading COP472-3's. BPC of the master is connected to BPA of each slave. The following table summarizes the function of bits six and seven:

Q7	Q6	Function	<b>BPC Output</b>	<b>BPA Output</b>
1	1	Slave	Backplane Output	Oscillator Input
0	1	Stand Alone	Backplane Output	Backplane Output
1	0	Not Used	Internal	Oscillator
0	0	Master	Osc. Output Internal Osc. Output	Input Backplane Output

The eighth bit is used to synchronize two COP472-3's to drive an  $81\!/_{\!2}\text{-digit}$  display.

### LOADING SEQUENCE TO DRIVE A 41/2-DIGIT DISPLAY

Steps:

- 1. Turn  $\overline{\text{CE}}$  low.
- 2. Clock in 8 bits of data for digit 1.
- 3. Clock in 8 bits of data for digit 2.
- 4. Clock in 8 bits of data for digit 3.
- 5. Clock in 8 bits of data for digit 4.
- Clock in 8 bits of data for special segment and control function of BPC and BPA.

0 0 1 1 1 SP4 SP3 SP2 SP1

#### 7. Turn CS high.

Note:  $\overline{CS}$  may be turned high after any step. For example to load only 2 digits of data, do steps 1, 2, 3, and 7.

 $\overline{\text{CS}}$  must make a high to low transition before loading data in order to reset internal counters.

# LOADING SEQUENCE TO DRIVE AN 8½-DIGIT DISPLAY

Two or more COP472-3's may be connected together to drive additional segments. An eight digit multiplexed display is shown in *Figure 7*. The following is the loading sequence to drive an eight digit display using two COP472-3's. The right chip is the master and the left the slave.

#### Steps:

- 1. Turn  $\overline{\text{CS}}$  low on both COP472-3's.
- 2. Shift in 32 bits of data for the slave's four digits.
- Shift in 4 bits of special segment data: a zero and three ones.



This synchronizes both the chips and BPA is oscillator input. Both chips are now stopped.

- 4. Turn CS high to both chips.
- 5. Turn CS low to master COP472-3.
- 6. Shift in 32 bits of data for the master's 4 digits.
- 7. Shift in four bits of special segment data, a one and three zeros.



This sets the master COP472-3 to BPA as a normal backplane output and BPC as oscillator output. Now both the chips start and run off the same oscillator.

8. Turn CS high.

The chips are now synchronized and driving 8 digits of display. To load new data simply load each chip separately in the normal manner, keeping the correct status bits to each COP472-3 (0110 or 0001).

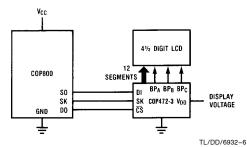


FIGURE 6. System Diagram - 4½ Digit Display

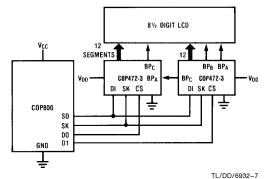
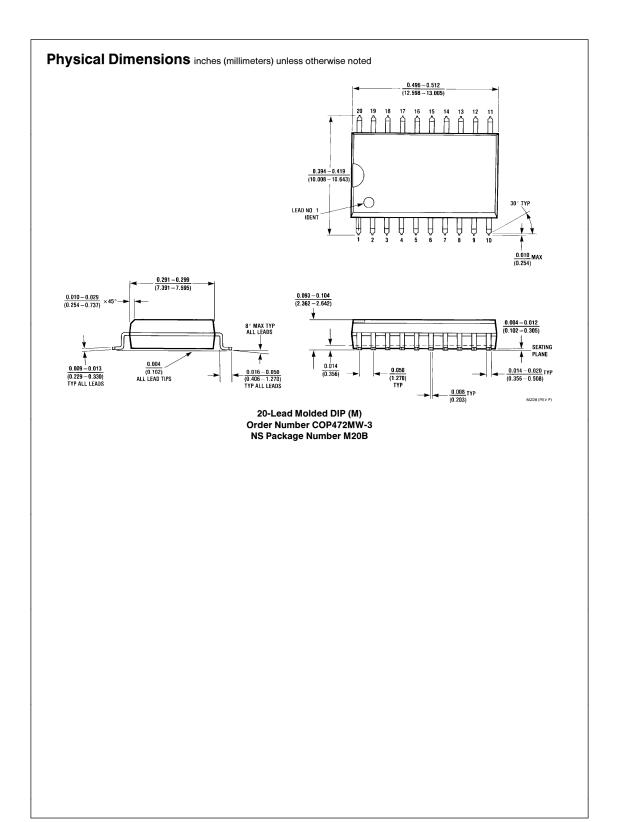
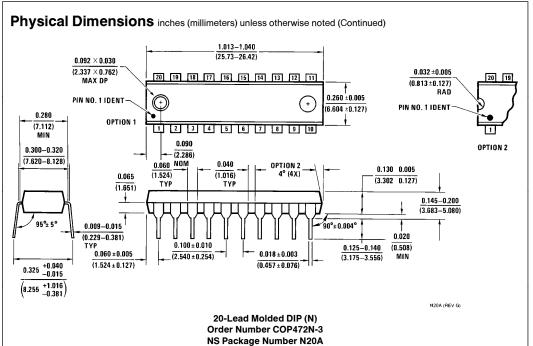


FIGURE 7. System Diagram - 81/2 Digit Display





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